

**LC898023**

## **32× Playback/12× Write CD-R/RW Encoder/Decoder IC with Built-in SCSI Interface**

**Preliminary****BURN-Proof™**

### **Functions**

- CD-ROM decoder/encoder functions
- CD decoder/encoder functions
- Pit and wobble CLV servo
- CAV audio functions
- SCSI interface (include the register block)
- Subcode encoder/decoder functions
- ATIP demodulator/ATIP decoder
- Write strategy function (CD-R/RW)
- CD-DSP function with built-in digital servo

### **Features**

- ECC and EDC correction/addition (decoding/encoding) for CD-ROM data.
- ECC error correction/addition (decoding/encoding) for subcode data
- Servo control implemented in a digital servo system (decoding/encoding)
- Wobble CLV servo control using ATIP data (encoding)
- ATIP decoding function and CRC check function (decoding/encoding)
- CIRC code generation and addition and EFM modulation (encoding)
- CAV audio functions
- Write strategy function supports 8× and 12× recording.
- Built-in SCSI interface (supports Ultra SCSI)
- Supports 32× decoding and 12× encoding.  
Clock frequencies: CD-ROM block: 33.8688 MHz,  
SCSI block: 20 MHz
- Ultra SCSI data transfer rate: 20 Mbyte/s (Maximum synchronous transfer rate), Fast SCSI: 10 Mbyte/s (Maximum synchronous transfer rate), 5 Mbyte/s

"BURN-Proof" stands for Proof against Buffer Under Run error, not for proof against burning.

"BURN-Proof" is a trademark of SANYO Electric Co.,Ltd.

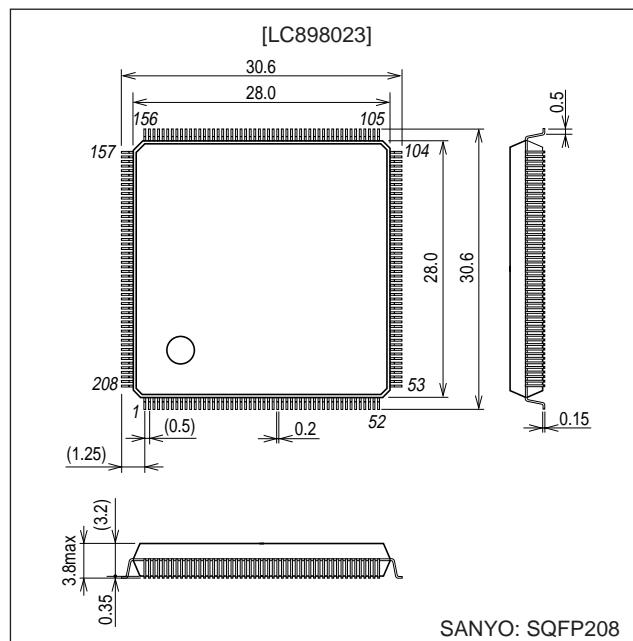
(Maximum asynchronous transfer rate)

Uses 16-bit data bus 50 ns EDO DRAM.

- From 1 to 64 Mbits of buffer RAM can be used. (16-bit data bus EDO DRAM)
- The user can freely set up the CD main channel, C2 flag, and subcode areas in buffer RAM.
- Batch transfer function (Function for transferring the CD main channel, C2 flag, subcode, and other data in a single operation)
- Multi-transfer function (Function for automatically transferring multiple blocks to the host in a single operation)

### **Package Dimensions**

unit: mm

**3210-SQFP208**

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## Specifications

### Absolute Maximum Ratings at $V_{SS} = 0 \text{ V}$

| Parameter                        | Symbol                | Conditions                 | Ratings                 | Unit |
|----------------------------------|-----------------------|----------------------------|-------------------------|------|
| Supply voltage                   | $V_{DD5} \text{ max}$ | Ta $\leq 25^\circ\text{C}$ | -0.3 to +6.0            | V    |
|                                  | $V_{DD3} \text{ max}$ | Ta $\leq 25^\circ\text{C}$ | -0.3 to +4.6            | V    |
| I/O voltages                     | $V_I5, V_O5$          | Ta $\leq 25^\circ\text{C}$ | -0.3 to $V_{DD5} + 0.3$ | V    |
|                                  | $V_I3, V_O3$          | Ta $\leq 25^\circ\text{C}$ | -0.3 to $V_{DD3} + 0.3$ | V    |
| Allowable power dissipation      | Pd max                | Ta $\leq 70^\circ\text{C}$ | 750                     | mW   |
| Operating temperature            | Topr                  |                            | -30 to +70              | °C   |
| Storage temperature              | Tstg                  |                            | -55 to +125             | °C   |
| Soldering conditions (pins only) |                       | 10 seconds                 | 260                     | °C   |

### Allowable Operating Ranges at $Ta = -30 \text{ to } +70^\circ\text{C}$ , $V_{SS} = 0 \text{ V}$

| Parameter                            | Symbol    | Conditions | Ratings |     |           | Unit |
|--------------------------------------|-----------|------------|---------|-----|-----------|------|
|                                      |           |            | min     | typ | max       |      |
| [I/O cells, 5.0 V power supply]      |           |            |         |     |           |      |
| Supply voltage                       | $V_{DD5}$ |            | 4.5     | 5.0 | 5.5       | V    |
| Input voltage range                  | $V_{IN}$  |            | 0       |     | $V_{DD5}$ | V    |
| [Internal cells, 3.3 V power supply] |           |            |         |     |           |      |
| Supply voltage                       | $V_{DD3}$ |            | 3.0     | 3.3 | 3.6       | V    |
| Input voltage range                  | $V_{IN}$  |            | 0       |     | $V_{DD3}$ | V    |

### Electrical Characteristics at $Ta = -30 \text{ to } +70^\circ\text{C}$ , $V_{SS} = 0 \text{ V}$ , $V_{DD} = 4.5 \text{ to } 5.5 \text{ V}$

| Parameter                 | Symbol    | Conditions   | Ratings        |     |              | Unit          |
|---------------------------|-----------|--|----------------|-----|--------------|---------------|
|                           |           |  | min            | typ | max          |               |
| High-level input voltage  | $V_{IH}$  | TTL level inputs: (2), (14)                            | 2.2            |     |              | V             |
| Low-level input voltage   | $V_{IL}$  |  |                |     | 0.8          | V             |
| High-level input voltage  | $V_{IH}$  | TTL level inputs with built-in pull-up resistors: (13) | 2.2            |     |              | V             |
| Low-level input voltage   | $V_{IL}$  |  |                |     | 0.8          | V             |
| High-level input voltage  | $V_{IH}$  | TTL level Schmitt trigger inputs: (1)                  | 2.5            |     |              | V             |
| Low-level input voltage   | $V_{IL}$  |  |                |     | 0.6          | V             |
| High-level input voltage  | $V_{IH}$  | (15)   | 2.0            |     |              | V             |
| Low-level input voltage   | $V_{IL}$  |  |                |     | 0.8          | V             |
| High-level input voltage  | $V_{IH}$  | CMOS level Schmitt trigger inputs: (3)                 | 0.8 $V_{DD}$   |     |              | V             |
| Low-level input voltage   | $V_{IL}$  |  |                |     | 0.2 $V_{DD}$ | V             |
| High-level input voltage  | $V_{IH}$  | CMOS level inputs with built-in pull-up resistors: (4) | 0.7 $V_{DD}$   |     |              | V             |
| Low-level input voltage   | $V_{IL}$  |  |                |     | 0.3 $V_{DD}$ | V             |
| Analog input voltage      | $V_{ANI}$ | (5)  | 1/4 $V_{DD}$   |     | 3/4 $V_{DD}$ | V             |
| High-level output voltage | $V_{OH}$  | $I_{OH} = -12 \text{ mA}$ : (8)                        | $V_{DD} - 2.1$ |     |              | V             |
| Low-level output voltage  | $V_{OL}$  | $I_{OL} = 12 \text{ mA}$ : (8)                         |                |     | 0.4          | V             |
| High-level output voltage | $V_{OH}$  | $I_{OH} = -8 \text{ mA}$ : (7)                         | $V_{DD} - 2.1$ |     |              | V             |
| Low-level output voltage  | $V_{OL}$  | $I_{OL} = 8 \text{ mA}$ : (7)                          |                |     | 0.4          | V             |
| High-level output voltage | $V_{OH}$  | $I_{OH} = -2 \text{ mA}$ : (6), (13), (14)             | $V_{DD} - 2.1$ |     |              | V             |
| Low-level output voltage  | $V_{OL}$  | $I_{OL} = 2 \text{ mA}$ : (6), (13), (14)              |                |     | 0.4          | V             |
| Low-level output voltage  | $V_{OL}$  | $I_{OL} = 48 \text{ mA}$ : (15)                        |                |     | 0.4          | V             |
| Low-level output voltage  | $V_{OL}$  | $I_{OL} = 8 \text{ mA}$ : (12)                         |                |     | 0.4          | V             |
| Low-level output voltage  | $V_{OL}$  | $I_{OL} = 1 \text{ mA}$ : (9)                          |                |     | 0.4          | V             |
| High-level output voltage | $V_{OH}$  | $I_{OH} = -4 \text{ mA}$ : (11)                        | $V_{DD} - 2.1$ |     |              | V             |
| Low-level output voltage  | $V_{OL}$  | $I_{OL} = 4 \text{ mA}$ : (11)                         |                |     | 0.4          | V             |
| Analog output voltage     | $V_{ANO}$ | (10)   | 1/4 $V_{DD}$   |     | 3/4 $V_{DD}$ | V             |
| Input leakage current     | $I_{IL}$  | $V_I = V_{SS}$ , $V_{DD}$ : (1), (2), (14), (15)       | -10            |     | +10          | $\mu\text{A}$ |
| Output leakage current    | $I_{OZ}$  | In the high-impedance output state: (9), (11), (12)    | -10            |     | +10          | $\mu\text{A}$ |
| Pull-up resistance        | $R_{UP}$  | (12), (13)   | 40             | 80  | 160          | k $\Omega$    |
| Pull-up resistance        | $R_{UP}$  | (4)  | 50             | 100 | 200          | k $\Omega$    |

The applicable pin groups are listed on the following page.

**Applicable Pins****[INPUT]**

- (1) ..... WOBBLE,  $\overline{CS}$ ,  $\overline{RD}$ ,  $\overline{WR}$ , DEF, HFL, TES
- (2) ..... SUA0 to SUA7, TEST0 to TEST4, RESET
- (3) ..... WRITE
- (4) ..... FG
- (5) ..... AD0, AD1, RREC, FE, TE, VREF, FR, OPP, JITIN, PCKISTF, PCKISTP, EFMIN, EFMIN2, SLCIST1, SLCIST2

**[OUTPUT]**

- (6) ..... LDON
- (7) ..... EFMG, SHOCK, LOCK, EFMO, SSP2/1, RAPC, WAPC, H11TO, LDH, ATTEST3, ATTEST1, WDAT, NWDT
- (8) ..... PCK2, RA0 to RA9,  $\overline{CAS0}$  to  $\overline{CAS1}$ ,  $\overline{RAS0}$  to  $\overline{RAS2}$ ,  $\overline{LWE}$ ,  $\overline{UWE}$ ,  $\overline{OE}$ , SUBSYNC
- (9) ..... PDS1 to PDS3
- (10) ..... DA0 to DA2, TDO, FDO, SLDO, SPDO, JITC, LOUT, ROUT, PDO, RPO, SLDO, SLCO1 to SLCO3
- (11) ..... DSLB
- (12) .....  $\overline{INT0}$ ,  $\overline{INT1}$ ,  $\overline{SWAIT}$

**[INOUT]**

- (13) ..... D0 to D7, ID0 to ID15
- (14) ..... ATIPSYNC, BICLK, BIDATA, ACRCNG
- (15) .....  $\overline{ACK}$ ,  $\overline{ATN}$ ,  $\overline{BSY}$ , C/D,  $\overline{DB0}$  to  $\overline{DB7}$ ,  $\overline{DBP}$ , I/O,  $\overline{MSG}$ ,  $\overline{REQ}$ ,  $\overline{RST}$ ,  $\overline{SEL}$

Note: The XTAL0, XTAL1, XTALCK0, and XTALCK1 are not included in the DC characteristics.

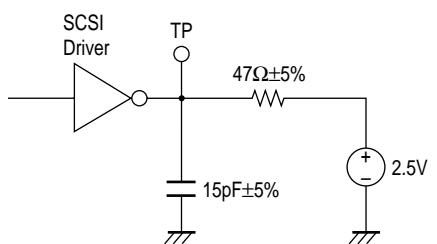
**SCSI Pin Input Characteristics**

| Parameter               | Symbol           | Conditions                  | Ratings |      |      | Unit |
|-------------------------|------------------|-----------------------------|---------|------|------|------|
|                         |                  |                             | min     | typ  | max  |      |
| Input threshold voltage | $V_{t+t_1}$      | $V_{DD} = 4.50$ to $5.50$ V |         |      | 1.60 | 2.00 |
|                         | $V_{t-t_1}$      | $V_{DD} = 4.50$ to $5.50$ V | 0.80    | 1.10 |      | V    |
| Hysteresis width        | $\Delta V_{tt1}$ | $V_{DD} = 5.0$ V            | 0.41    | 0.5  |      |      |

**Active Negation Output Characteristics**

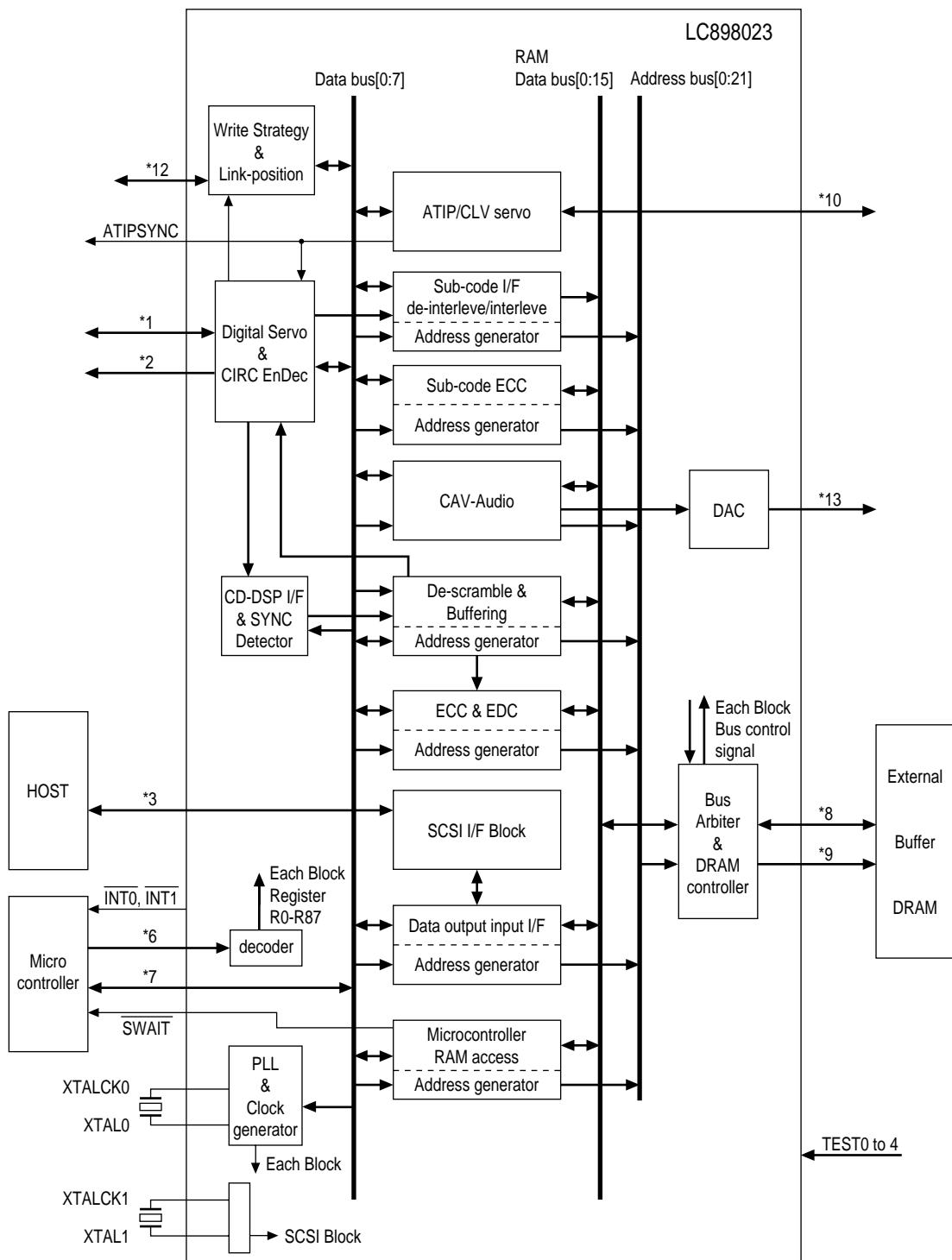
| Parameter           | Symbol   | Conditions | Ratings |     |     | Unit |
|---------------------|----------|------------|---------|-----|-----|------|
|                     |          |            | min     | typ | max |      |
| Output high voltage | $V_{OH}$ |            | 2.5     |     |     | V    |
| Output low voltage  | $V_{OL}$ |            |         |     | 0.4 | V    |

Note: The active negation output characteristics only applies to  $\overline{DB0}$  to  $\overline{DB7}$ ,  $\overline{REQ}$ , and  $\overline{DBPB}$

**Rise Time Test Circuit**

A13188

## Block Diagram



A13191

- \*1 DSLB (pin96) to FR (pin123), AD0 (pin127) to SPDO (pin142), SHOCK (pin147) to PCK2 (pin155)
- \*2 SUBSYNC
- \*3 DB0 to DB7, DBP, BSY, MSG, SEL, RST, REQ, I/O, C/D, ACK, ATN
- \*6 RD, WR, SUA0 to SUA7, CS
- \*7 D0 to D7
- \*8 IO0 to IO15
- \*9 RA0 to RA9, RAS0, RAS1, RAS2, CAS0, CAS1, OE, UWE, LWE
- \*10 Wobble, Bidata, BICLK
- \*12 WRITE, SSP2/1, RAPC, WAPC, H11T0, LDH, TEST2/1, WDAT, NWDAT, EFMG
- \*13 LOUT, ROUT

**Pin Functions**

| Pin No. | Pin name        | Type | Pin function                             |       |            |                   |    |               |
|---------|-----------------|------|--|-------|------------|-------------------|----|---------------|
|         |                 |      | I  | Input | B          | Bidirectional pin | NC | Not connected |
| O       | Output          | P    | Power supply                             | A     | Analog pin |                   |    |               |
| 1       | V <sub>SS</sub> | P    | Digital system ground (V <sub>SS</sub> ) |       |            |                   |    |               |
| 2       | RA4             | O    |  |       |            |                   |    |               |
| 3       | RA5             | O    |  |       |            |                   |    |               |
| 4       | RA6             | O    |  |       |            |                   |    |               |
| 5       | RA7             | O    |  |       |            |                   |    |               |
| 6       | RA8             | O    |  |       |            |                   |    |               |
| 7       | RA9             | O    |  |       |            |                   |    |               |
| 8       | V <sub>DD</sub> | P    | Digital system power supply (5 V)        |       |            |                   |    |               |
| 9       | V <sub>SS</sub> | P    | Digital system ground (V <sub>SS</sub> ) |       |            |                   |    |               |
| 10      | IO0             | B    |  |       |            |                   |    |               |
| 11      | IO1             | B    |  |       |            |                   |    |               |
| 12      | IO2             | B    |  |       |            |                   |    |               |
| 13      | IO3             | B    |  |       |            |                   |    |               |
| 14      | IO4             | B    |  |       |            |                   |    |               |
| 15      | IO5             | B    |  |       |            |                   |    |               |
| 16      | V <sub>DD</sub> | P    | Digital system power supply (3.3 V)      |       |            |                   |    |               |
| 17      | V <sub>SS</sub> | P    | Digital system ground (V <sub>SS</sub> ) |       |            |                   |    |               |
| 18      | IO6             | B    |  |       |            |                   |    |               |
| 19      | IO7             | B    |  |       |            |                   |    |               |
| 20      | IO8             | B    |  |       |            |                   |    |               |
| 21      | IO9             | B    |  |       |            |                   |    |               |
| 22      | IO10            | B    |  |       |            |                   |    |               |
| 23      | V <sub>SS</sub> | P    | Digital system ground (V <sub>SS</sub> ) |       |            |                   |    |               |
| 24      | V <sub>DD</sub> | P    | Digital system power supply (5 V)        |       |            |                   |    |               |
| 25      | IO11            | B    |  |       |            |                   |    |               |
| 26      | IO12            | B    |  |       |            |                   |    |               |
| 27      | IO13            | B    |  |       |            |                   |    |               |
| 28      | IO14            | B    |  |       |            |                   |    |               |
| 29      | IO15            | B    |  |       |            |                   |    |               |
| 30      | ATIPSYNC        | I    | ATIP SYNC detection signal               |       |            |                   |    |               |
| 31      | BIDATA          | B    |  |       |            |                   |    |               |
| 32      | BICLK           | B    |  |       |            |                   |    |               |
| 33      | WOBBLE          | I    |  |       |            |                   |    |               |
| 34      | V <sub>DD</sub> | P    | Digital system power supply (5 V)        |       |            |                   |    |               |
| 35      | V <sub>SS</sub> | P    | Digital system ground (V <sub>SS</sub> ) |       |            |                   |    |               |
| 36      | ACRCNG          | O    | ATIP CRC error signal                    |       |            |                   |    |               |
| 37      | WRITE           | I    | Write strategy signal control input      |       |            |                   |    |               |
| 38      | SSP2            | O    | Servo sampling pulse output              |       |            |                   |    |               |
| 39      | SSP1            | O    | Servo sampling pulse output              |       |            |                   |    |               |
| 40      | RAPC            | O    | Laser control sampling pulse output      |       |            |                   |    |               |
| 41      | WAPC            | O    | Laser control sampling pulse output      |       |            |                   |    |               |
| 42      | H11T0           | O    | Running OPC sampling pulse               |       |            |                   |    |               |

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| Pin No. | Pin name        | Type | Pin function   |
|---------|-----------------|------|--|
| 43      | LDH             | O    | Recording laser diode control signal output  |
| 44      | V <sub>DD</sub> | P    | Digital system power supply (3.3 V)  |
| 45      | V <sub>SS</sub> | P    | Digital system ground (V <sub>SS</sub> )   |
| 46      | ATEST3          | O    | Analog block test output   |
| 47      | ATEST1          | O    | Analog block test output   |
| 48      | WDAT            | O    | Recording laser diode control signal output  |
| 49      | NWDAT           | O    | Recording laser diode control signal output (WDAT inverted)  |
| 50      | V <sub>DD</sub> | P    | Analog system power supply (3.3 V)   |
| 51      | V <sub>SS</sub> | P    | Analog system ground (V <sub>SS</sub> )  |
| 52      | V <sub>DD</sub> | P    | Digital system power supply (5 V)  |
| 53      | V <sub>SS</sub> | P    | Digital system ground (V <sub>SS</sub> )   |
| 54      | R1              | I    | Write strategy analog signals  |
| 55      | VCNT1           | I    |  |
| 56      | MDC1            | I    |  |
| 57      | PD1             | O    |  |
| 58      | SWAIT           | O    | Wait signal to the microcontroller   |
| 59      | INT0            | O    | Interrupt request signal outputs to the microcontroller<br>These are open-drain outputs with built-in pull-up resistors. |
| 60      | INT1            | O    |  |
| 61      | D0              | B    | Microcontroller data signal lines<br>These pins have built-in pull-up resistors.   |
| 62      | D1              | B    |  |
| 63      | D2              | B    |  |
| 64      | D3              | B    |  |
| 65      | D4              | B    |  |
| 66      | D5              | B    |  |
| 67      | D6              | B    |  |
| 68      | V <sub>DD</sub> | P    | Digital system power supply (5 V)  |
| 69      | V <sub>SS</sub> | P    | Digital system ground (V <sub>SS</sub> )   |
| 70      | D7              | B    | Microcontroller data signal line   |
| 71      | SUA0            | I    | Command register selection address   |
| 72      | SUA1            | I    |  |
| 73      | SUA2            | I    |  |
| 74      | SUA3            | I    |  |
| 75      | SUA4            | I    |  |
| 76      | SUA5            | I    |  |
| 77      | SUA6            | I    |  |
| 78      | SUA7            | I    |  |
| 79      | CS              | I    | Chip select signal input from the microcontroller  |
| 80      | RD              | I    | Data read signal from the microcontroller  |
| 81      | WR              | I    | Data write signal from the microcontroller   |
| 82      | TEST0           | I    | Test pin. This pin must be tied to V <sub>SS</sub> .   |
| 83      | VCNT            | I    | VCO control voltage  |
| 84      | R               | I    | VCO bias resistor connection   |
| 85      | PD              | O    | Charge pump output   |
| 86      | V <sub>DD</sub> | P    | Analog system power supply (3.3 V)   |
| 87      | V <sub>SS</sub> | P    | Analog system ground (V <sub>SS</sub> )  |
| 88      | TEST1           | I    | Test pin. This pin must be tied to V <sub>SS</sub> .   |
| 89      | RESET           | I    | Reset input  |
| 90      | XTALCK0         | I    | Crystal oscillator circuit input (33.8688 MHz)   |

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| Pin No. | Pin name        | Type | Pin function   |
|---------|-----------------|------|--|
| 91      | XTAL0           | O    | Crystal oscillator circuit output                    |
| 92      | ROUT            | O    | D/A converter output                                 |
| 93      | V <sub>SS</sub> | P    | Analog system ground (V <sub>SS</sub> )              |
| 94      | V <sub>DD</sub> | P    | Analog system power supply (5 V)                     |
| 95      | LOUT            | O    | D/A converter output                                 |
| 96      | DSLBB           | O    | SLC PWM output                                       |
| 97      | SLCIST1         | I    | EFM slice level setting input                        |
| 98      | SLCIST2         | I    |  |
| 99      | V <sub>SS</sub> | P    | Analog system ground (V <sub>SS</sub> )              |
| 100     | V <sub>DD</sub> | P    | Analog system power supply (3.3 V)                   |
| 101     | SLCO0           | O    | EFM slice level output                               |
| 102     | SLCO1           | O    |  |
| 103     | SLCO2           | O    |  |
| 104     | V <sub>DD</sub> | P    | Digital system power supply (5 V)                    |
| 105     | V <sub>SS</sub> | P    | Digital system ground (V <sub>SS</sub> )             |
| 106     | SLCO3           | O    | EFM slice level output                               |
| 107     | EFMIN           | I    | EFM input  |
| 108     | EFMIN2          | I    |  |
| 109     | JITIN           | I    | Jitter discrimination input                          |
| 110     | JITC            | O    | Jitter output  |
| 111     | RPO             | O    | P/N balance adjustment                               |
| 112     | OPP             | I    |  |
| 113     | PCKISTF         | I    | Frequency comparator charge pump                     |
| 114     | PCKISTP         | I    | Phase comparator charge pump                         |
| 115     | V <sub>SS</sub> | P    | Analog system ground (V <sub>SS</sub> )              |
| 116     | V <sub>DD</sub> | P    | Analog system power supply (3.3 V)                   |
| 117     | PDO             | O    | Charge pump filter                                   |
| 118     | PDS1            | O    | Charge pump selection                                |
| 119     | PDS2            | O    |  |
| 120     | V <sub>DD</sub> | P    | Digital system power supply (3.3 V)                  |
| 121     | V <sub>SS</sub> | P    | Digital system ground (V <sub>SS</sub> )             |
| 122     | PDS3            | O    | Charge pump selection                                |
| 123     | FR              | I    | VCO frequency setting                                |
| 124     | TEST2           | I    | Test pin. This pin must be tied to V <sub>SS</sub> . |
| 125     | TEST3           | I    | Test pin. This pin must be tied to V <sub>SS</sub> . |
| 126     | TEST4           | I    | Test pin. This pin must be tied to V <sub>SS</sub> . |
| 127     | AD0             | I    | AD input   |
| 128     | RREC            | I    | Optical signal discrimination input                  |
| 129     | FE              | I    | FE input   |
| 130     | TE              | I    | TE input   |
| 131     | VREF            | I    | VREF input   |
| 132     | AD1             | I    | AD input   |
| 133     | V <sub>SS</sub> | P    | Analog system ground (V <sub>SS</sub> )              |
| 134     | DA0             | O    | DA output  |
| 135     | DA1             | O    | DA output  |
| 136     | DA2             | O    | DA output  |
| 137     | TDO             | O    | Tracking output                                      |

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| Pin No. | Pin name        | Type | Pin function   |
|---------|-----------------|------|--|
| 138     | V <sub>DD</sub> | P    | Analog system power supply (5 V)                         |
| 139     | V <sub>Ss</sub> | P    | Analog system ground (V <sub>Ss</sub> )                  |
| 140     | FDO             | O    | Focus output   |
| 141     | SLDO            | O    | Sled output  |
| 142     | SPDO            | O    | Spindle output   |
| 143     | V <sub>Ss</sub> | P    | Digital system ground (V <sub>Ss</sub> )                 |
| 144     | V <sub>DD</sub> | P    | Digital system power supply (3.3 V)                      |
| 145     | SUBSYNC         | O    | Subcode SYNC signal                                      |
| 146     | EFMG            | O    | EFM gate signal  |
| 147     | SHOCK           | O    | Shock detection signal output                            |
| 148     | LOCK            | O    | PLL lock state output                                    |
| 149     | DEF             | I    | Defect detection signal input                            |
| 150     | HFL             | I    | Mirror detection signal input                            |
| 151     | TES             | I    | TES comparator input                                     |
| 152     | EFMO            | O    | Post-binarization EFM signal output                      |
| 153     | LDON            | O    | Laser control  |
| 154     | FG              | I    | FG input   |
| 155     | PCK2            | O    | PCK output   |
| 156     | V <sub>DD</sub> | P    | Digital system power supply (5 V)                        |
| 157     | V <sub>Ss</sub> | P    | Digital system ground (V <sub>Ss</sub> )                 |
| 158     | XTALCK1         | I    | SCSI interface crystal oscillator circuit input (20 MHz) |
| 159     | XTAL1           | O    | SCSI interface crystal oscillator circuit output         |
| 160     | <u>DB0</u>      | B    | SCSI connection  |
| 161     | V <sub>Ss</sub> | P    | Digital system ground (V <sub>Ss</sub> )                 |
| 162     | <u>DB1</u>      | B    | SCSI connection  |
| 163     | <u>DB2</u>      | B    |  |
| 164     | V <sub>DD</sub> | P    | Digital system power supply (5 V)                        |
| 165     | <u>DB3</u>      | B    | SCSI connection  |
| 166     | <u>DB4</u>      | B    |  |
| 167     | V <sub>Ss</sub> | P    | Digital system ground (V <sub>Ss</sub> )                 |
| 168     | <u>DB5</u>      | B    | SCSI connection  |
| 169     | <u>DB6</u>      | B    |  |
| 170     | <u>DB7</u>      | B    | SCSI connection  |
| 171     | V <sub>Ss</sub> | P    | Digital system ground (V <sub>Ss</sub> )                 |
| 172     | V <sub>DD</sub> | P    | Digital system power supply (5 V)                        |
| 173     | V <sub>Ss</sub> | P    | Digital system ground (V <sub>Ss</sub> )                 |
| 174     | <u>DBP</u>      | B    | SCSI connection  |
| 175     | <u>ATN</u>      | B    |  |
| 176     | <u>BSY</u>      | B    | SCSI connection  |
| 177     | V <sub>Ss</sub> | P    | Digital system ground (V <sub>Ss</sub> )                 |
| 178     | <u>ACK</u>      | B    | SCSI connection  |
| 179     | <u>RST</u>      | B    |  |
| 180     | V <sub>DD</sub> | P    | Digital system power supply (5 V)                        |
| 181     | <u>MSG</u>      | B    | SCSI connection  |
| 182     | <u>SEL</u>      | B    |  |
| 183     | V <sub>Ss</sub> | P    | Digital system ground (V <sub>Ss</sub> )                 |
| 184     | C/D             | B    | SCSI connection  |

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| Pin No. | Pin name        | Type | Pin function                              |
|---------|-----------------|------|---|
| 185     | V <sub>SS</sub> | P    | Digital system ground (V <sub>SS</sub> )  |
| 186     | V <sub>DD</sub> | P    | Digital system power supply (5 v)         |
| 187     | <u>REQ</u>      | B    |   |
| 188     | I/O             | B    | SCSI connections                          |
| 189     | V <sub>SS</sub> | P    | Digital system ground (V <sub>SS</sub> )  |
| 190     | V <sub>DD</sub> | P    | Digital system power supply (3.3 V)       |
| 191     | V <sub>SS</sub> | P    | Digital system ground (V <sub>SS</sub> )  |
| 192     |                 | NC   | Unused                                    |
| 193     |                 | NC   | Unused                                    |
| 194     | <u>RAS0</u>     | O    |   |
| 195     | <u>RAS1</u>     | O    | DRAM <u>RAS</u> signal outputs            |
| 196     | <u>RAS2</u>     | O    |   |
| 197     | <u>LWE</u>      | O    | DRAM lower write enable                   |
| 198     | V <sub>DD</sub> | P    | Digital system power supply (5 V)         |
| 199     | V <sub>SS</sub> | P    | Digital system ground (V <sub>SS</sub> )  |
| 200     | <u>UWE</u>      | O    | DRAM upper write enable                   |
| 201     | <u>CAS0</u>     | O    |   |
| 202     | <u>CAS1</u>     | O    | DRAM <u>CAS</u> signal output             |
| 203     | <u>OE</u>       | O    | DRAM output enable                        |
| 204     | RA0             | O    |   |
| 205     | RA1             | O    |   |
| 206     | RA2             | O    | CD-ROM encoder/decoder DRAM address lines |
| 207     | RA3             | O    |   |
| 208     | V <sub>DD</sub> | P    | Digital system power supply (5 V)         |

## Pin Functions

<SCSI Interface Pins>

**BSY, ACK, MSG, SEL, REQ, ATN, RST, I/O, C/D** (input/output)

SCIS bus control.

**DB0 to DB7, DBP** (input/output)

SCSI data bus.

<Microcontroller Interface Pins>

**CS** (input)

Chip select signal from the microcontroller. The microcontroller interface is active when this pin is low.

**RD, WR** (input)

Connect the microcontroller read and write lines to these inputs.

**SWAIT** (input)

Wait signal output to the microcontroller. When accessing buffer RAM, the microcontroller must wait if this pin is low.

**SUA0 to SUA7** (input)

Internal register address lines

**D0 to D7** (input)

Microcontroller data bus. These pins have built-in pull-up resistors.

**INT0, INT1** (output)

Interrupt request signals output to the microcontroller. INT1 can be set to output the ATAPI interrupt by setting INT1EN (Conf-R11 bit 7)

These are open drain outputs with built-in 80 kΩ (at room temperature, 5 V) pull-up resistors.

<Buffer RAM Pins>

**I/O0 to I/O15** (input/output)

Buffer RAM data bus. These pins have built-in pull-up resistors.

**RA0 to RA9** (output)

Buffer RAM address lines.

**RAS0, RAS1, RAS2** (output)

Buffer DRAM RAS outputs. Normally, RAS0 is used. However, if two 16-Mbit DRAMs are used, connect the RAS0 and RAS1 lines to the RAS pins on the DRAMs. If four 16-Mbit DRAMs are used, connect the RAS0, RAS1, RAS2, and LWE lines to the RAS pins on the DRAMs.

**CAS0, CAS1** (output)

Buffer DRAM CAS outputs. Normally, CAS0 is used. However, if two 16-Mbit DRAMs are used, connect the CAS0 output to the CAS pins on the DRAMs. If 2-CAS type DRAMs are used, connect CAS0 to UCAS and CAS1 to LCAS.

**OE** (output)

Buffer RAM read output.

**UWE, LWE** (output)

Buffer RAM write outputs. Connect these to the corresponding pins. If 2-CAS type DRAMs are used, UWE must be connected. (Leave LWE open.)

## 1. Analog Interface Pins

**RREC** (input)

Optical discrimination input.

**FE** (input)

Focus error signal input.

**TE** (input)

Tracking error signal input.

**VREF** (input)

Input for the servo system reference voltage.

**AD0, AD1, AD2** (input)

A/D converter auxiliary inputs.

**DA0, DA1, DA2** (input)

D/A converter auxiliary inputs.

**TES** (input)

TES comparator input.

**TDO** (output)

Tracking control signal output.

**FDO** (output)

Focus control signal output.

**SLDO** (output)

Sled control signal output.

**SPDO** (output)

Spindle control signal output.

## 2. EFM Input Block Pins

**EFMIN** (input)

EFM signal input.

The high-frequency components of the RF signal acquired from the RF amplifier are cut with a capacitor, and this pin inputs that signal biased by the value of the SLCO0 to SLCO3 outputs passed through a low-pass filter.

**EFMIN2** (input)

Used to change the time constant of the low-pass filter.

**SLCIST1, SLCIST2** (input)

Slice level controller charge pump bias resistor connection.

**SLCO0, SLCO1, SLCO2, SLCO3** (output)

Slice level controller charge pump outputs.

These levels bias the RF signal input to the EFMIN pin after being passed through a low-pass filter.

**DSLB** (output)

Slice level control PWM output.

**EFMO** (output)

Post-binariization EFM signal output. (For monitoring)

## 3. EFM Clock Generation Block Pins

**FR** (input)

EFM reproduction PLL VCO bias resistor connection.

**PDO, PDS1, PDS2, PDS3** (output)

EFM reproduction PLL lag-lead filter connection.

**PCKISTF** (input)

EFM reproduction PLL frequency comparator charge pump bias resistor connection.

**PCKISTP** (input)

EFM reproduction PLL phase comparator charge pump bias resistor connection.

**RPO** (output)

P/N balance adjustment.

**OPP** (input)

P/N balance adjustment.

**PCK2** (output)

EFM reproduction bit clock output.

## 4. Jitter Discrimination Pins

**JITIN** (input)

Jitter discrimination input.

**JITC** (output)

Jitter output.

## 5. Spindle Speed Detection Pins

**FG** (input)

Input for the speed monitor signal from the spindle driver.

## 6. Audio Interface Pins

**LOUT, ROUT** (output)

Left and right channel audio signal outputs.

## 7. RF Amplifier Interface Pins

**LDON** (output)

RF amplifier interface.

## 8. Write Strategy Pins

**WRITE, SSP2/1, RAPC, WAPC, H11T0, LDH, ATEST3, 1, WDAT, NWDAT** (I/O)

Write strategy signal connections.

## 9. ATIP Decoder Related Pins

**ATIPSYNC** (output)

ATIP synchronization detection signal. (For monitoring)

**BIDATA, BICLK** (I/O)

Input mode: Input of the biphasic data and biphasic clock when an external ATIP demodulator is used.

Output mode: Output of the biphasic data and biphasic clock when the internal ATIP demodulator is used. (For monitoring)

**WOBBLE** (input)

Wobble signal is input when the internal ATIP demodulator is used.

**ACRCNG** (output)

Outputs the result of the ATIP decoder CRC check. (For monitoring)

## &lt;Other Pins&gt;

**RESET** (input)

The LC898023 reset input. A low level input resets the LC898023.

This pin must be held low for at least 1  $\mu$ s when power is first applied.

**TEST4 to TEST0** (input)

Test inputs. These pins must be connected to ground.

**XTALCK0** (input), **XTAL0** (output)

Drive these pins at 33.8688 MHz. This signal is used, without modification, as main clock for the CD-ROM encoder and decoder blocks, including the DRAM interface.

**XTALCK1** (input), **XTAL1** (output)

Main clock for the SCSI block. The LC898023 is designed so that it can operate even when the ECC and SCSI blocks are not synchronized. Providing a 20 MHz input to the XTALCK0 and XTALCK1 pins assures that correct, synchronized transfer at 10 Mbyte/s (20 Mbyte/s for Ultra SCSI) can be achieved. The maximum frequency that can be used is 20 MHz.

Since both edges of the clock signal are used by Ultra SCSI, the duty ratio must be correct. Add feedback resistors on the XTALCK1 and XTAL1 pins and take other measures as required.

**R, VCNT, PDO, R1, VCNT1, PD1, MDC1** (I/O)

Clock reproduction PLL circuit pins.

**SUBSYNC** (output)

Subcode SYNC output signal from the CIRC encoder during recording. (For monitoring)

**EFMG** (output)

Outputs a high level during recording.

**SHOCK** (output)

Outputs a high level when a mechanical shock is detected.

**LOCK** (output)

Outputs a high level when the PLL circuit is locked.

**DEF** (input)

Inputs the defect detection signal.

**HFL** (input)

Inputs the mirror detection signal.

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